## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT7881959

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
SHIH-LIEN LINUS LU	04/16/2019

#### **RECEIVING PARTY DATA**

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.	
Street Address:	8, LI-HSIN RD. 6, HSINCHU SCIENCE PARK	
City:	HSINCHU	
State/Country:	TAIWAN	
Postal Code:	300-78	

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	18295134

#### **CORRESPONDENCE DATA**

Fax Number: (703)518-5499

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 7036841111 Email: tsmc@ipfirm.com **Correspondent Name:** HAUPTMAN HAM, LLP

Address Line 1: 2318 MILL ROAD, SUITE 1400 Address Line 4: ALEXANDRIA, VIRGINIA 22314

ATTORNEY DOCKET NUMBER:	T5057-1317B
NAME OF SUBMITTER:	RANDY A. NORANBROCK
SIGNATURE:	/Randy A. Noranbrock/
DATE SIGNED:	04/03/2023

**Total Attachments: 1** 

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REEL: 063209 FRAME: 0561 507834821

**PATENT** 

JCZPO

Docket No. T5057-1317 P20172006US00

### ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

1) Shih-Lien Linus LU

RECORDED: 04/03/2023

who has made a certain new and useful invention, hereby sells, assigns and transfers unto <u>TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.</u>, having a place of business at No. 8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu 300, Taiwan R.O.C.

# its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled MEMORY CELL ARRAY AND METHOD OF OPERATING SAME for which an application for United States Letters Patent was filed on \_\_\_\_\_\_\_, and identified by United States Patent Application No. \_\_\_\_\_\_\_; or (a) for which an application for United States Letters Patent was executed on . . . . (b) and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefore and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE; AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred. SIGNED on the date indicated aside my signature: 1) Shib-Lien Linus LU 4/16/2019 Date:

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PATENT REEL: 063209 FRAME: 0562